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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10026052	FILING DATE 12/21/2001	CLASS 438	SUBCLASS 6.1	GAU 2812	EXAMINER <i>M. Scheer</i>
**APPLICANTS: Forster James; Rincon Reynaldo; Arnold Richard; Wilson Lester;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED:					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO TI-32569	
Verified and Acknowledged Examiners's initials TITLE : Low cost area array probe for circuits having solder-ball contacts are manufactured using a wire bonding machine					
U.S. DEPT. OF COMM./PAT. & TM: PTO-436 (Rev. 12-04)					

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED		
			Total Claims	Print Claim for O.G.	
ISSUE FEE		Primary Examiner	DRAWING		
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.	Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner		
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